Electronic Patent Application Fee Transmittal							
Application Number:	10	10787269					
Filing Date:	25	25-Feb-2004					
Title of Invention:	Se	Semiconductor package with heat dissipating structure					
First Named Inventor/Applicant Name:	CI	Chien-Ping Huang					
Filer:	St	Steven M. Jensen					
Attorney Docket Number:	58	58102-DIV (71987)					
Filed as Large Entity							
Utility Filing Fees							
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)		
Basic Filing:							
Pages:							
Claims:							
Miscellaneous-Filing:							
Petition:							
Patent-Appeals-and-Interference:							
Post-Allowance-and-Post-Issuance:							
Extension-of-Time:							
Extension - 1 month with \$0 paid		1251	1	120	120		

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)				
Miscellaneous:								
Request for continued examination	1801	1	790	790				
	Tota	910						